NIKO-SEM

Dual N-Channel Enhancement Mode Field Effect Transistor

PJ614DA

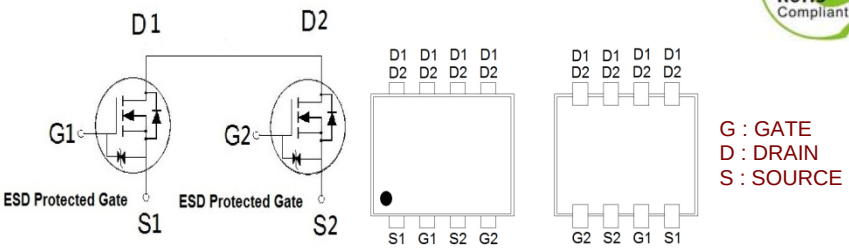
J-Lead

Halogen-Free & Lead-Free

RoHS Compliant

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
20V	11.8mΩ	10.5A



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	20	V
Gate-Source Voltage		V_{GS}	±10	V
Continuous Drain Current[2]	T_A = 25 °C	I_D	10.5	A
	T_A = 70 °C		8.4	
Pulsed Drain Current[1]		I_{DM}	28	
Avalanche Current		I_{AS}	22	
Avalanche Energy	L = 0.1mH	E_{AS}	24	mJ
Power Dissipation[3]	T_A = 25 °C	P_D	2.1	W
	T_A = 70 °C		1.3	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	t ≦10s	$R_{\theta JA}$		58	°C / W
Junction-to-Ambient	Steady-State	$R_{\theta JA}$		73	

[1]Pulse width limited by maximum junction temperature.
[2]Package limitation current is 7A.
[3]The Power dissipation is based on $R_{\theta JA}$ t ≦10s value.

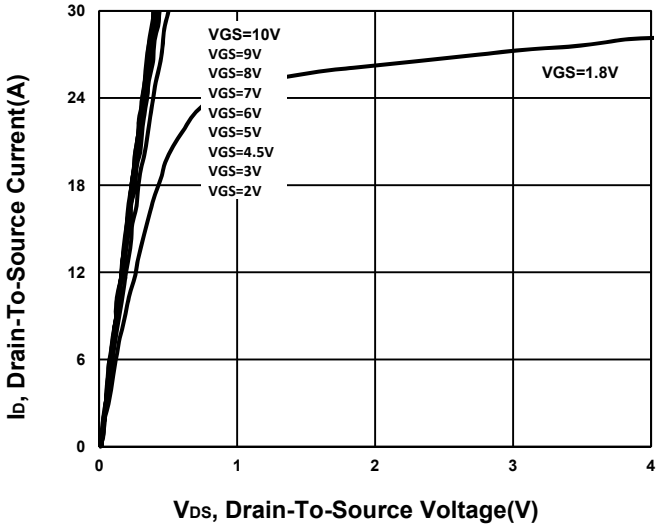
ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	0.35	0.7	1	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±8V			±30	uA

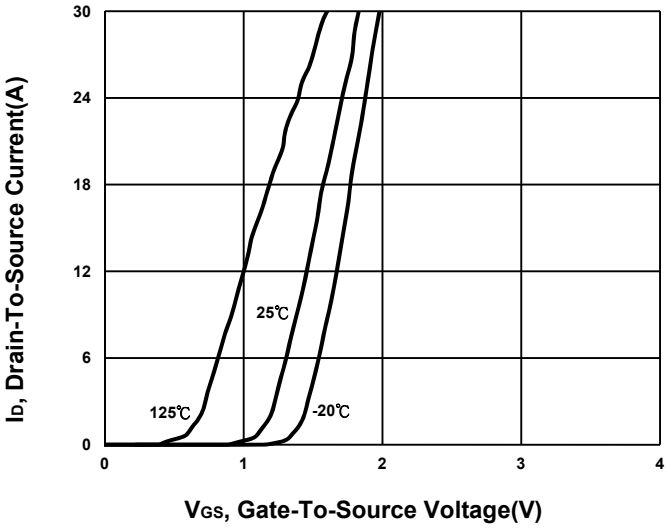
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 16V, V_{GS} = 0V			1	μA
		V_{DS} = 10V, V_{GS} = 0V, T_J = 70 °C			10	
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 2.5V, I_D = 3A	8.5	13	20	mΩ
		V_{GS} = 3.1V, I_D = 3A	7.8	11.5	15.3	
		V_{GS} = 3.8V, I_D = 3A	7.2	10.6	12.9	
		V_{GS} = 4.5V, I_D = 3A	7.1	10	11.8	
Forward Transconductance[1]	g_{fs}	V_{DS} = 5V, I_D = 3A		40		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 10V, f = 1MHz		1133		pF
Output Capacitance	C_{oss}			214		
Reverse Transfer Capacitance	C_{rss}			168		
Gate Resistance	R_g	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz		1.5		Ω
Total Gate Charge[2]	Q_g	V_{DS} = 10V , V_{GS} = 4.5V, I_D = 3A		17.4		nC
Gate-Source Charge[2]	Q_{gs}			1.1		
Gate-Drain Charge[2]	Q_{gd}			5.1		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DS} = 10V , $I_D \cong$ 3A, V_{GS} = 4.5V, R_G = 6 Ω		24		nS
Rise Time[2]	t_r			32		
Turn-Off Delay Time[2]	$t_{d(off)}$			66		
Fall Time[2]	t_f			35		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS						
Continuous Current	I_S				1.7	A
Forward Voltage[1]	V_{SD}	I_F = 3A, V_{GS} = 0V			1.2	V
Reverse Recovery Time	t_{rr}	I_F = 3A, dI_F/dt = 100A / μS		14		nS
Reverse Recovery Charge	Q_{rr}			5.4		nC

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.
[2]Independent of operating temperature.
[3]Pulse width limited by maximum junction temperature.

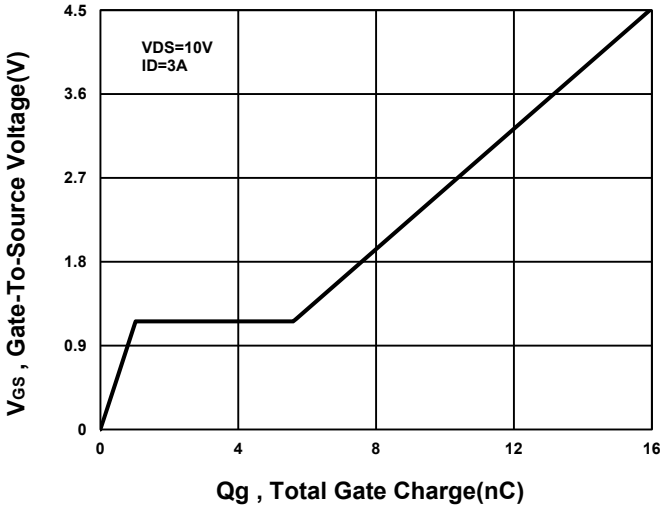
Output Characteristics



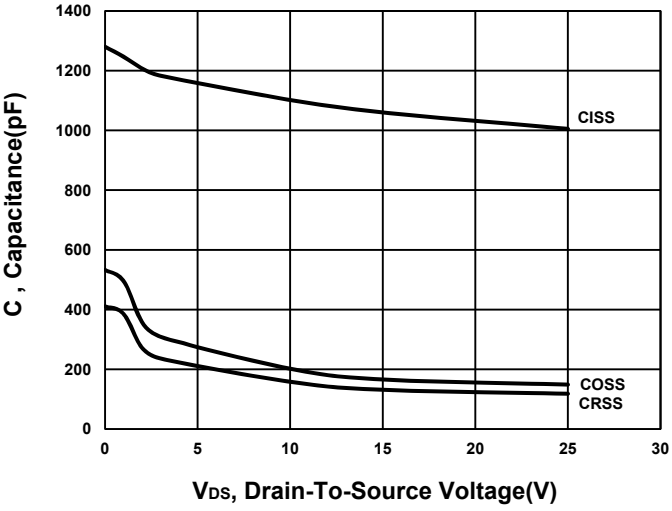
Transfer Characteristics



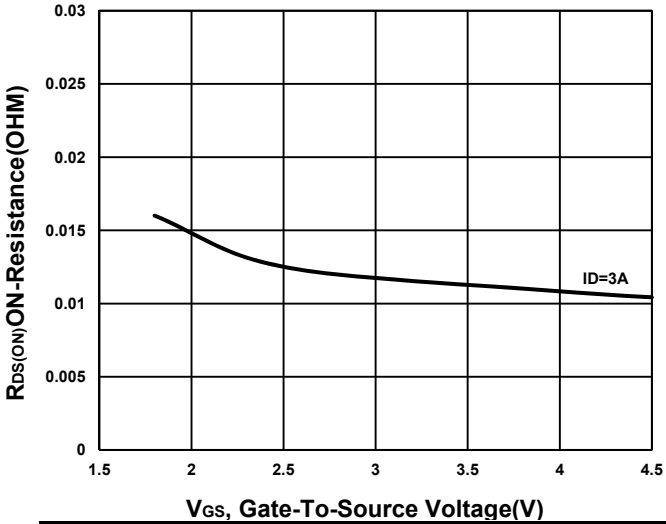
Gate charge Characteristics



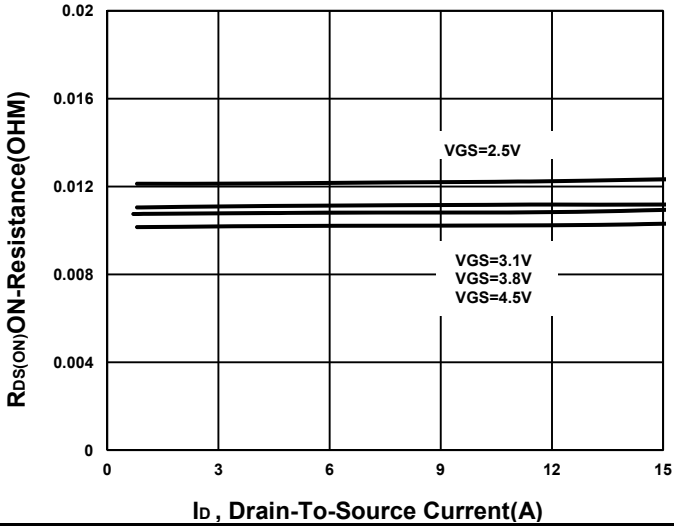
Capacitance Characteristic



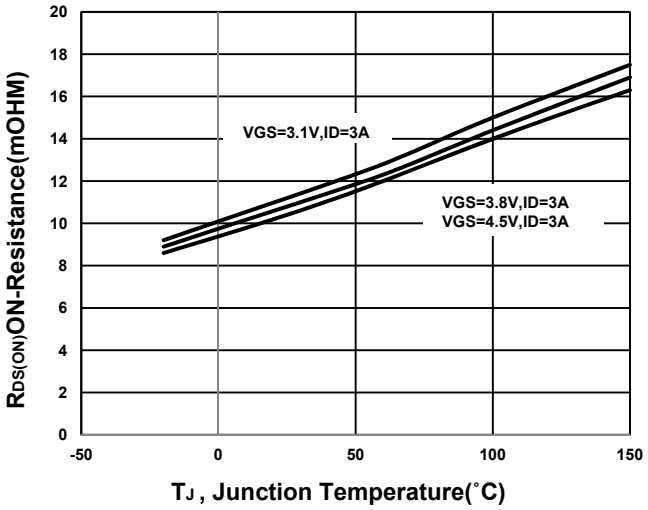
On-Resistance VS Gate-To-Source



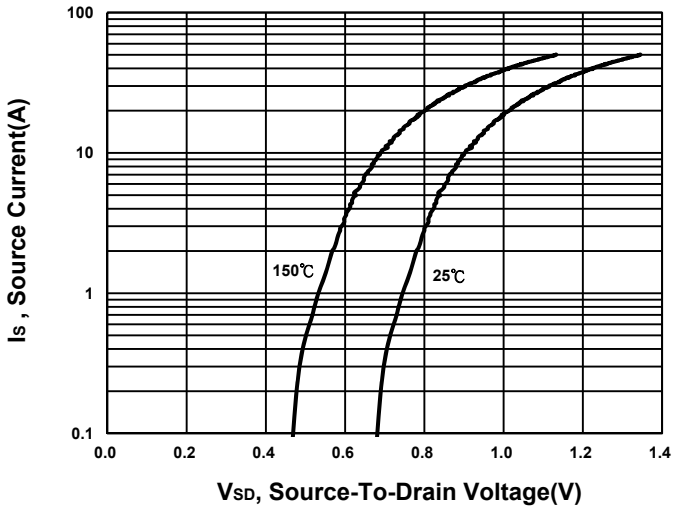
On-Resistance VS Drain Current



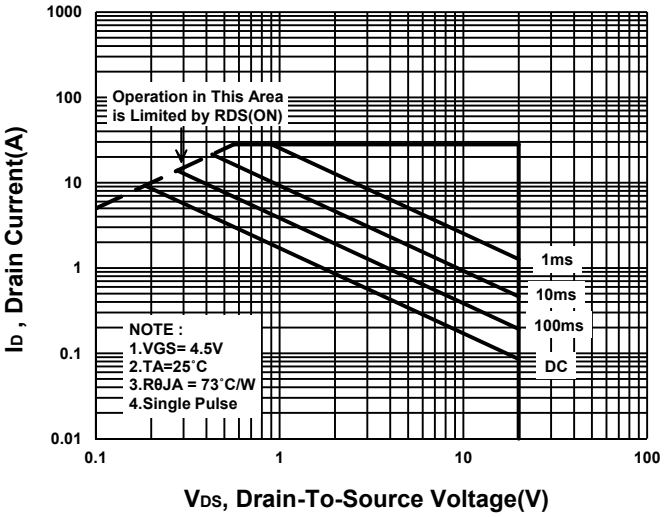
On-Resistance VS Temperature



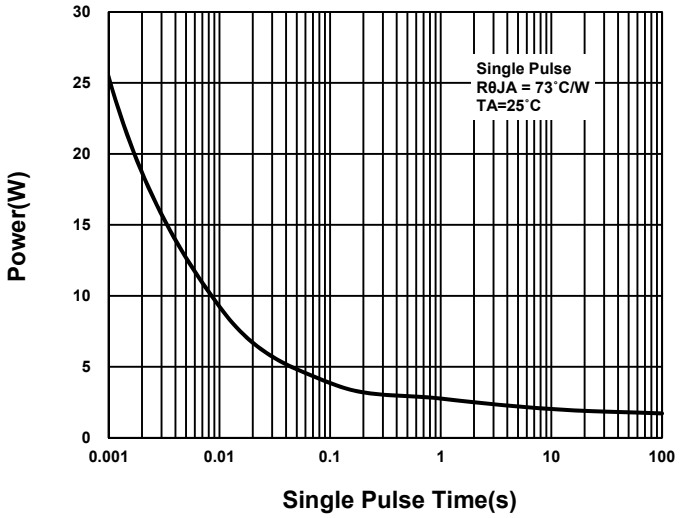
Source-Drain Diode Forward Voltage



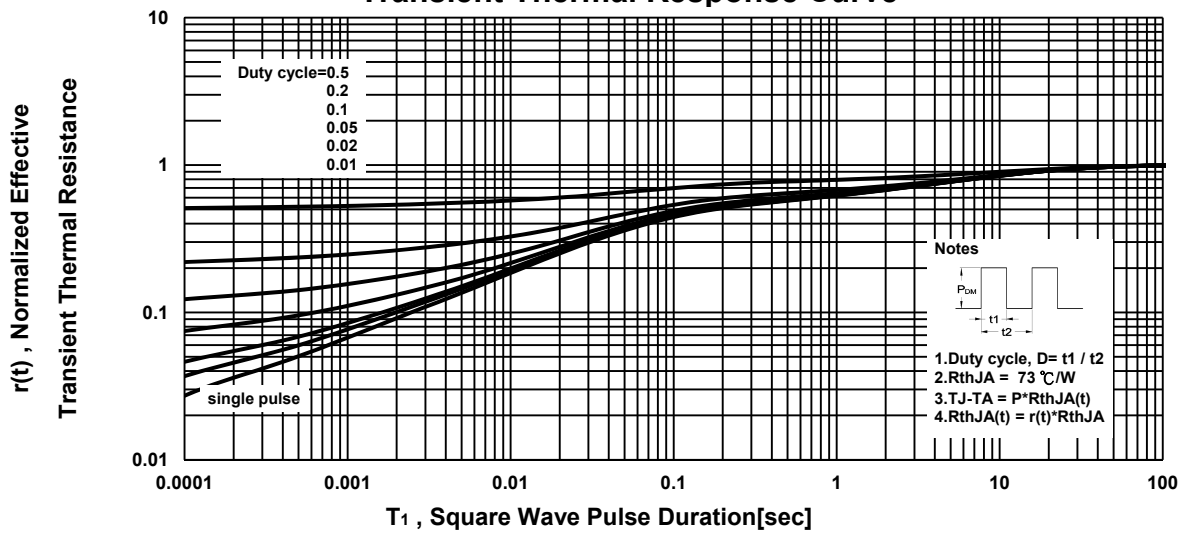
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET ***category:***

Click to view products by NIKO ***manufacturer:***

Other Similar products are found below :

614233C 648584F MCH3443-TL-E MCH6422-TL-E FDPF9N50NZ FW216A-TL-2W FW231A-TL-E APT5010JVR NTNS3A92PZT5G IRF100S201 JANTX2N5237 2SK2464-TL-E 2SK3818-DL-E FCA20N60_F109 FDZ595PZ STD6600NT4G FSS804-TL-E 2SJ277-DL-E 2SK1691-DL-E 2SK2545(Q,T) D2294UK 405094E 423220D MCH6646-TL-E TPCC8103,L1Q(CM 367-8430-0972-503 VN1206L 424134F 026935X 051075F SBVS138LT1G 614234A 715780A NTNS3166NZT5G 751625C 873612G IRF7380TRHR IPS70R2K0CEAKMA1 RJK60S3DPP-E0#T2 RJK60S5DPK-M0#T0 APT5010JVFR APT12031JFLL APT12040JVR DMN3404LQ-7 NTE6400 JANTX2N6796U JANTX2N6784U JANTXV2N5416U4 SQM110N05-06L-GE3 SIHF35N60E-GE3